

# VIPA System 200V

**IM | Manual**

HB97E\_IM | RE\_26x-1xA00 | Rev. 12/44

October 2012



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## About this manual

This manual describes the System 200V bus expansion module IM 26x from VIPA. Here you may find every information for commissioning and operation.

### Overview

#### **Chapter 1: Basics and Assembly**

The focus of this chapter is on the introduction of the VIPA System 200V. Here you will find the information required to assemble and wire a controller system consisting of System 200V components.

Besides the dimensions the general technical data of System 200V will be found.

#### **Chapter 2: Hardware description**

Here the hardware components of the IM 26x-1xA00 are described. The technical data are at the end of the chapter.

#### **Chapter 3: Deployment**

In this chapter follows the description of the bus expansion module IM 260 and IM 261. About the basic interface up to 3 System 200V row interfaces can be connected via cable.

Here the maximum number of 32 modules (16 digital modules and 16 analog modules) may not be exceeded.

**Objective and contents**

This manual describes the System 200V bus expansion module IM 26x from VIPA. It contains a description of the construction, project implementation and usage.

This manual is part of the documentation package with order number HB97E\_IM and relevant for:

Product	Order number	as of state: HW
IM 26x	VIPA 26x-1xA00	01

**Target audience**

The manual is targeted at users who have a background in automation technology.

**Structure of the manual**

The manual consists of chapters. Every chapter provides a self-contained description of a specific topic.

**Guide to the document**

The following guides are available in the manual:

- an overall table of contents at the beginning of the manual
- an overview of the topics for every chapter

**Availability**

The manual is available in:

- printed form, on paper
- in electronic form as PDF-file (Adobe Acrobat Reader)

**Icons Headings**

Important passages in the text are highlighted by following icons and headings:

**Danger!**

Immediate or likely danger.  
Personal injury is possible.

**Attention!**

Damages to property is likely if these warnings are not heeded.

**Note!**

Supplementary information and useful tips.

## Safety information

### Applications conforming with specifications

The IM 26x is constructed and produced for:

- all VIPA System 200V components
- communication and process control
- general control and automation applications
- industrial applications
- operation within the environmental conditions specified in the technical data
- installation into a cubicle



### Danger!

This device is not certified for applications in

- in explosive environments (EX-zone)

### Documentation

The manual must be available to all personnel in the

- project design department
- installation department
- commissioning
- operation



### The following conditions must be met before using or commissioning the components described in this manual:

- Hardware modifications to the process control system should only be carried out when the system has been disconnected from power!
- Installation and hardware modification only by properly trained personnel.
- The national rules and regulations of the respective country must be satisfied (installation, safety, EMC ...)

### Disposal

**National rules and regulations apply to the disposal of the unit!**



# Chapter 1 Basics and Assembly

## Overview

The focus of this chapter is on the introduction of the VIPA System 200V. Here you will find the information required to assemble and wire a controller system consisting of System 200V components. Besides the dimensions the general technical data of System 200V will be found.

## Contents

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## Safety Information for Users

### Handling of electrostatic sensitive modules

VIPA modules make use of highly integrated components in MOS-Technology. These components are extremely sensitive to over-voltages that can occur during electrostatic discharges.

The following symbol is attached to modules that can be destroyed by electrostatic discharges.



The Symbol is located on the module, the module rack or on packing material and it indicates the presence of electrostatic sensitive equipment.

It is possible that electrostatic sensitive equipment is destroyed by energies and voltages that are far less than the human threshold of perception. These voltages can occur where persons do not discharge themselves before handling electrostatic sensitive modules and they can damage components thereby, causing the module to become inoperable or unusable.

Modules that have been damaged by electrostatic discharges can fail after a temperature change, mechanical shock or changes in the electrical load.

Only the consequent implementation of protection devices and meticulous attention to the applicable rules and regulations for handling the respective equipment can prevent failures of electrostatic sensitive modules.

### Shipping of electrostatic sensitive modules

Modules must be shipped in the original packing material.

### Measurements and alterations on electrostatic sensitive modules

When you are conducting measurements on electrostatic sensitive modules you should take the following precautions:

- Floating instruments must be discharged before use.
- Instruments must be grounded.

Modifying electrostatic sensitive modules you should only use soldering irons with grounded tips.



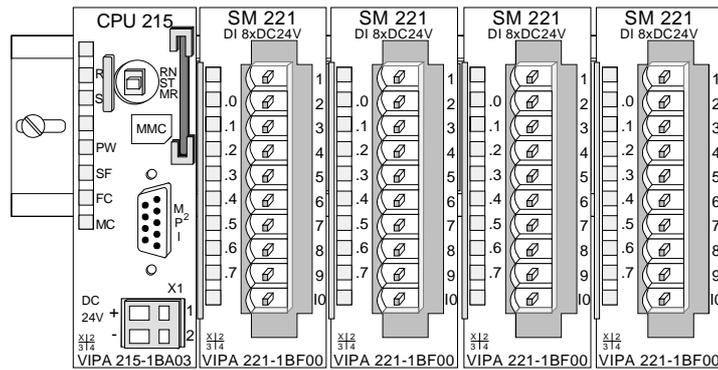
### Attention!

Personnel and instruments should be grounded when working on electrostatic sensitive modules.

# System conception

## Overview

The System 200V is a modular automation system for assembly on a 35mm profile rail. By means of the peripheral modules with 4, 8 and 16 channels this system may properly be adapted matching to your automation tasks.

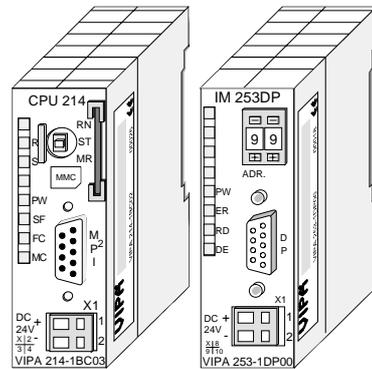


## Components

The System 200V consists of the following components:

- Head modules like CPU and bus coupler
- Periphery modules like I/O, function und communication modules
- Power supplies
- Extension modules

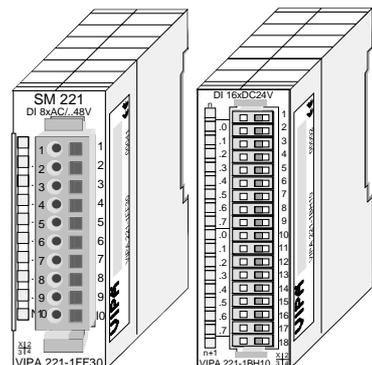
## Head modules



With a head module CPU respectively bus interface and DC 24V power supply are integrated to one casing.

Via the integrated power supply the CPU respectively bus interface is power supplied as well as the electronic of the connected periphery modules.

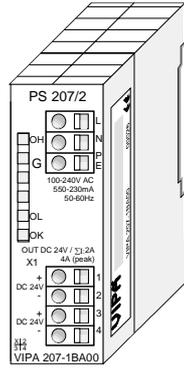
## Periphery modules



The modules are direct installed on a 35mm profile rail and connected to the head module by a bus connector, which was mounted on the profile rail before.

Most of the periphery modules are equipped with a 10pin respectively 18pin connector. This connector provides the electrical interface for the signaling and supplies lines of the modules.

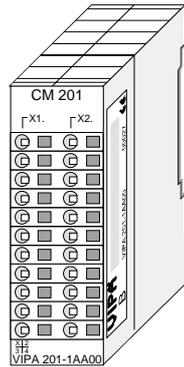
**Power supplies**



With the System 200V the DC 24V power supply can take place either externally or via a particularly for this developed power supply.

The power supply may be mounted on the profile rail together with the System 200V modules. It has no connector to the backplane bus.

**Expansion modules**



The expansion modules are complementary modules providing 2- or 3wire connection facilities.

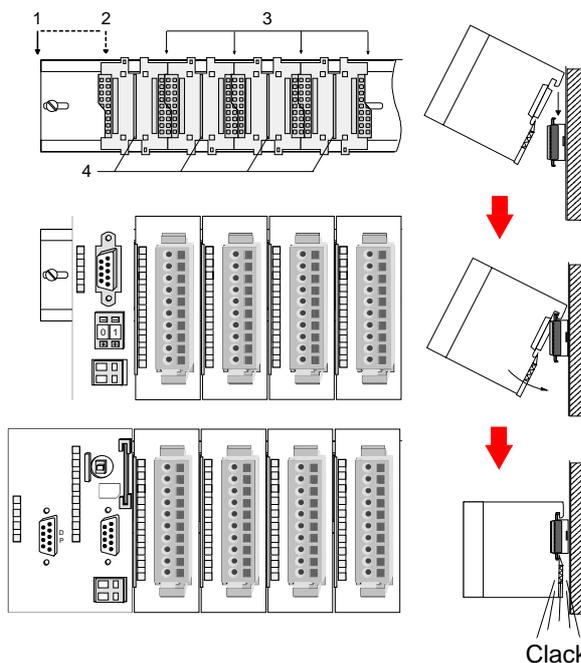
The modules are not connected to the backplane bus.

**Structure/ dimensions**

- Profile rail 35mm
- Dimensions of the basic enclosure:
  - 1tier width: (HxWxD) in mm: 76x25.4x74 in inches: 3x1x3
  - 2tier width: (HxWxD) in mm: 76x50.8x74 in inches: 3x2x3

**Installation**

Please note that you can only install head modules, like the CPU, the PC and couplers at slot 1 or 1 and 2 (for double width modules).



[1]	Head module (double width)
[2]	Head module (single width)
[3]	Periphery module
[4]	Guide rails

**Note**

Information about the max. number of pluggable modules and the max. current at the backplane bus can be found in the "Technical Data" of the according head module.

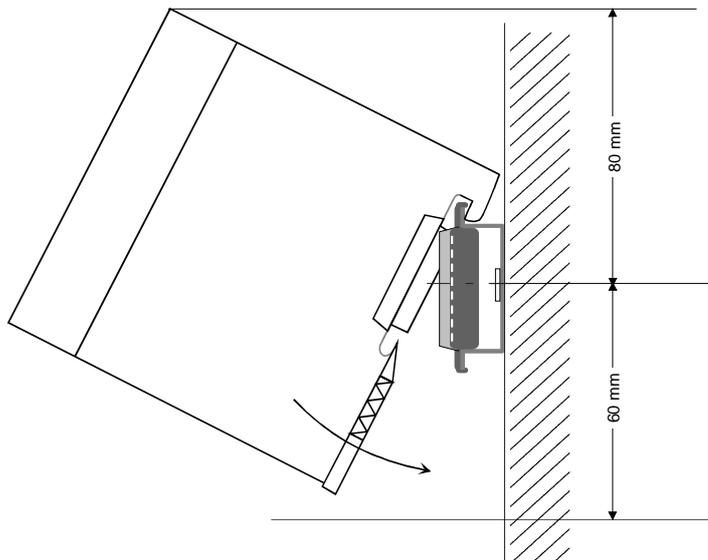
Please install modules with a high current consumption directly beside the head module.

## Dimensions

**Dimensions**  
**Basic enclosure**

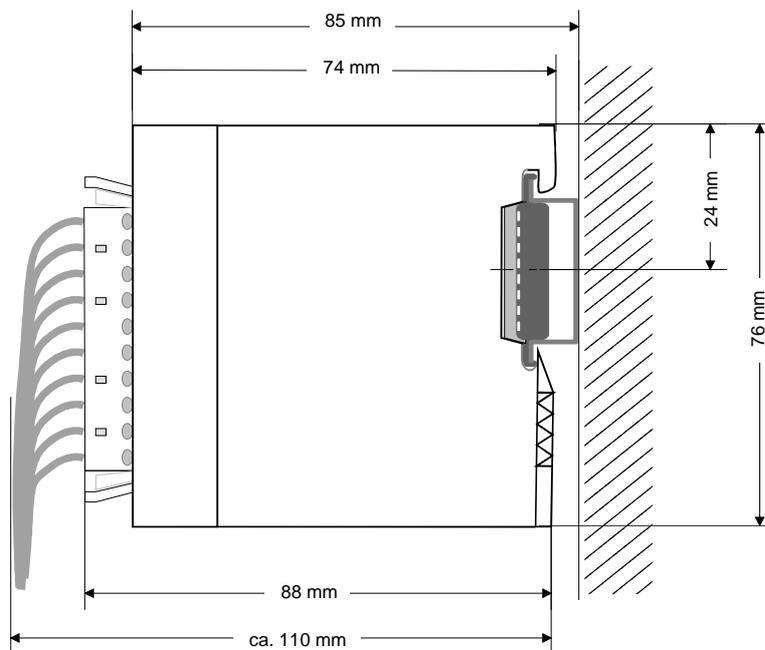
1tier width (HxWxD) in mm: 76 x 25.4 x 74  
2tier width (HxWxD) in mm: 76 x 50.8 x 74

**Installation**  
**dimensions**

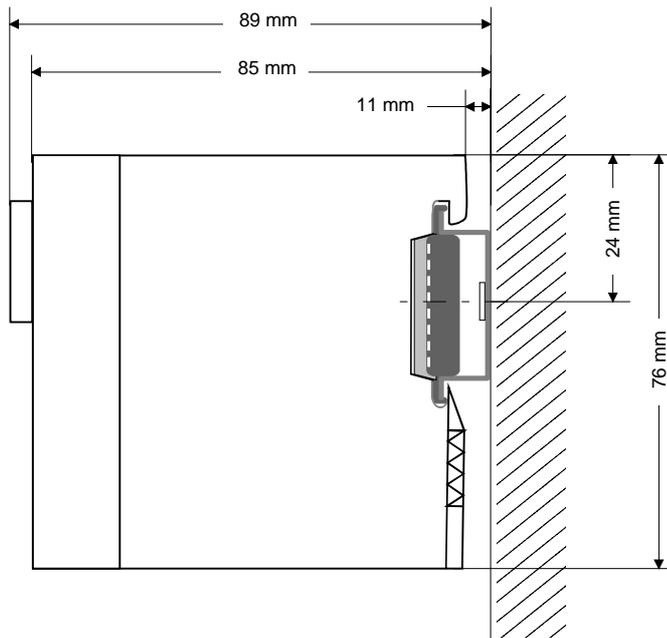


**Installed and wired**  
**dimensions**

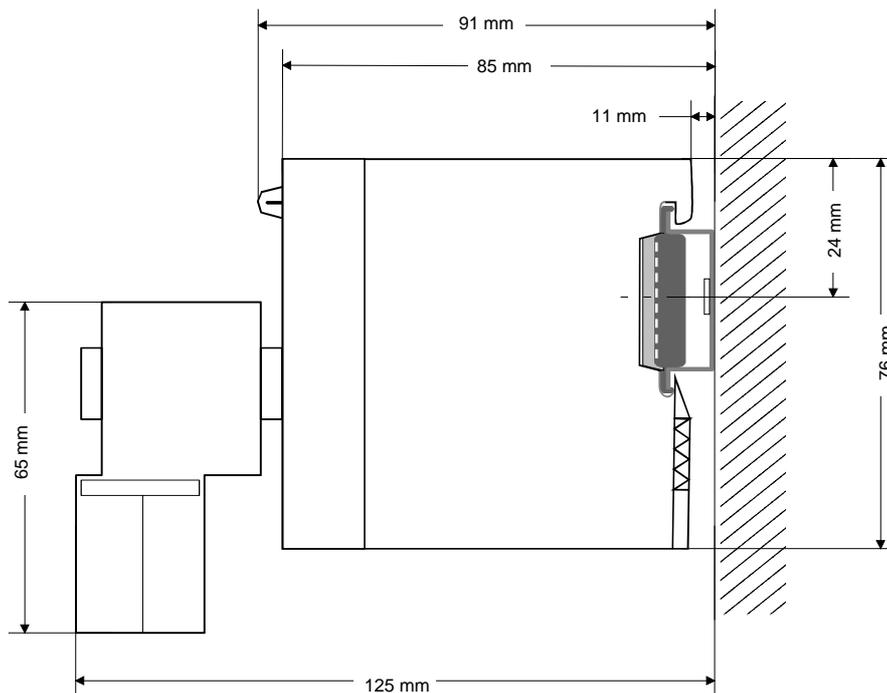
In- / Output  
modules



Function modules/  
Extension modules



CPUs (here with  
EasyConn from  
VIPA)



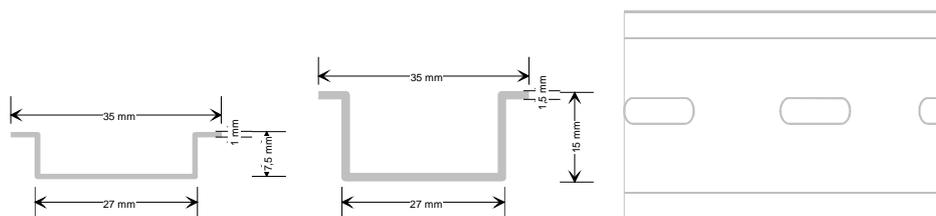
## Installation

### General

The modules are each installed on a 35mm profile rail and connected via a bus connector. Before installing the module the bus connector is to be placed on the profile rail before.

### Profile rail

For installation the following 35mm profile rails may be used:

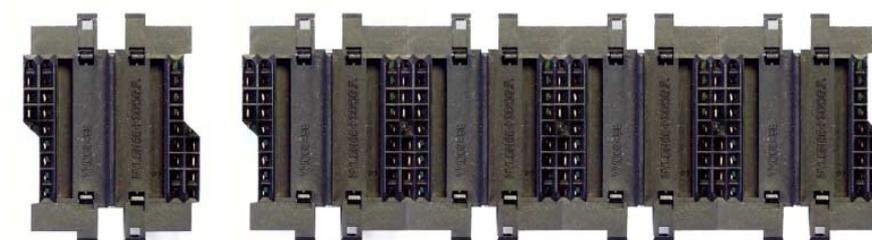


Order number	Label	Description
290-1AF00	35mm profile rail	Length 2000mm, height 15mm
290-1AF30	35mm profile rail	Length 530mm, height 15mm

### Bus connector

System 200V modules communicate via a backplane bus connector. The backplane bus connector is isolated and available from VIPA in of 1-, 2-, 4- or 8tier width.

The following figure shows a 1tier connector and a 4tier connector bus:



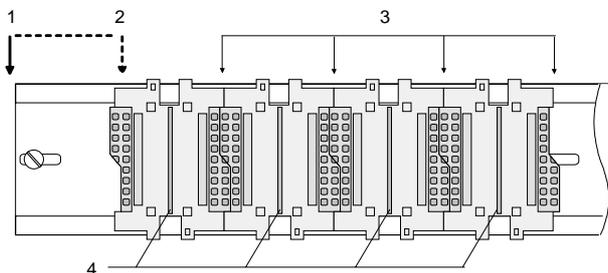
The bus connector is to be placed on the profile rail until it clips in its place and the bus connections look out from the profile rail.

Order number	Label	Description
290-0AA10	Bus connector	1tier
290-0AA20	Bus connector	2tier
290-0AA40	Bus connector	4tier
290-0AA80	Bus connector	8tier

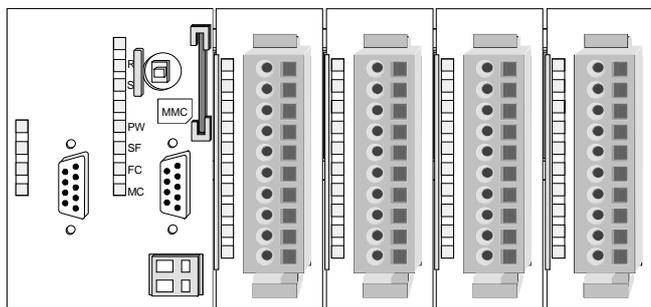
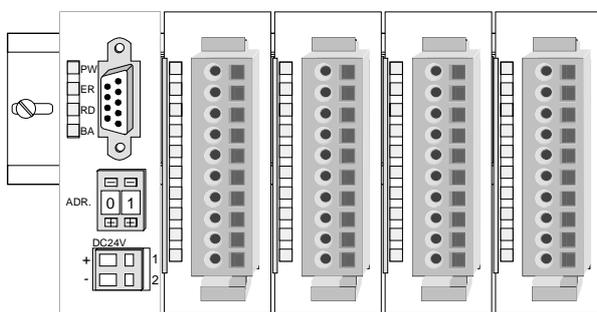
**Installation on a profile rail**

The following figure shows the installation of a 4tier width bus connector in a profile rail and the slots for the modules.

The different slots are defined by guide rails.



- [1] Head module (double width)
- [2] Head module (single width)
- [3] Peripheral module
- [4] Guide rails

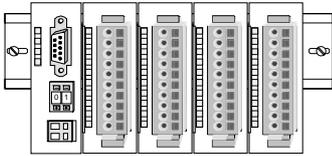


**Assembly regarding the current consumption**

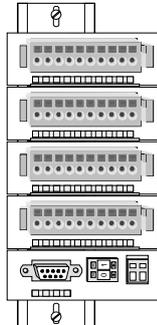
- Use bus connectors as long as possible.
- Sort the modules with a high current consumption right beside the head module. In the service area of [www.vipa.com](http://www.vipa.com) a list of current consumption of every System 200V module can be found.

**Assembly possibilities**

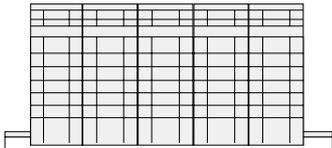
horizontal assembly



vertical assembly



lying assembly

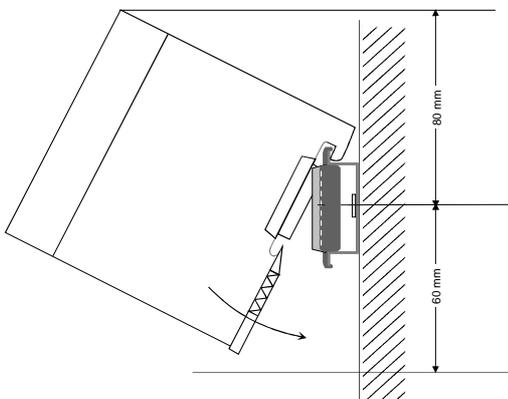


Please regard the allowed environmental temperatures:

- horizontal assembly: from 0 to 60°C
- vertical assembly: from 0 to 40°C
- lying assembly: from 0 to 40°C

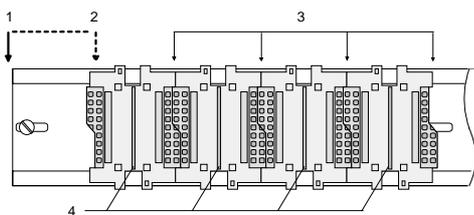
The horizontal assembly always starts at the left side with a head module, then you install the peripheral modules beside to the right.

You may install up to 32 peripheral modules.



**Please follow these rules during the assembly!**

- Turn off the power supply before you install or remove any modules!
- Make sure that a clearance of at least 60mm exists above and 80mm below the middle of the profile rail.



- Every row must be completed from left to right and it has to start with a head module.

- [1] Head module (double width)
- [2] Head module (single width)
- [3] Peripheral modules
- [4] Guide rails

- Modules are to be installed side by side. Gaps are not permitted between the modules since this would interrupt the backplane bus.
- A module is only installed properly and connected electrically when it has clicked into place with an audible click.
- Slots after the last module may remain unoccupied.

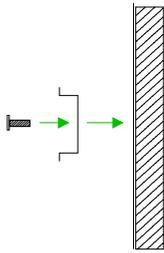


**Note!**

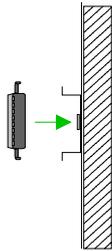
Information about the max. number of pluggable modules and the max. current at the backplane bus can be found in the "Technical Data" of the according head module.

Please install modules with a high current consumption directly beside the head module.

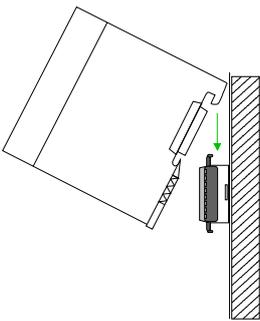
**Assembly procedure**



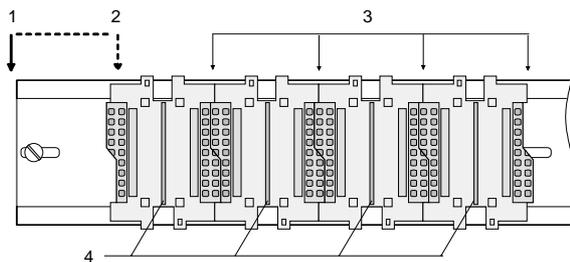
- Install the profile rail. Make sure that a clearance of at least 60mm exists above and 80mm below the middle of the profile rail.



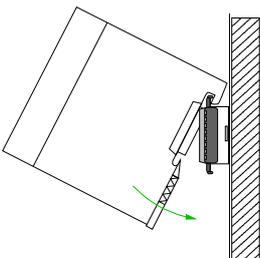
- Press the bus connector into the profile rail until it clips securely into place and the bus-connectors look out from the profile rail. This provides the basis for the installation of your modules.



- Start at the outer left location with the installation of your head module and install the peripheral modules to the right of this.



- [1] Head module (double width)
- [2] Head module (single width)
- [3] Peripheral module
- [4] Guide rails

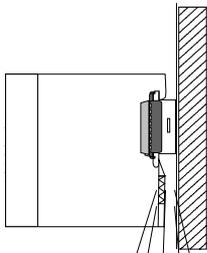


- Insert the module that you are installing into the profile rail at an angle of 45 degrees from the top and rotate the module into place until it clicks into the profile rail with an audible click. The proper connection to the backplane bus can only be guaranteed when the module has properly clicked into place.



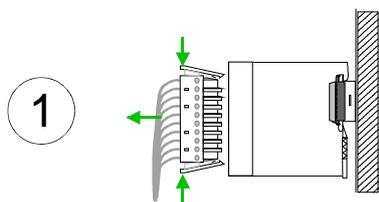
**Attention!**

Power must be turned off before modules are installed or removed!

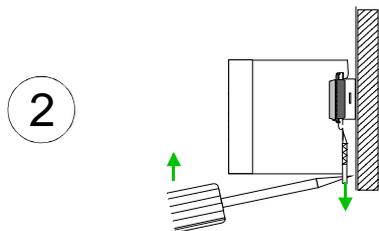


Clack

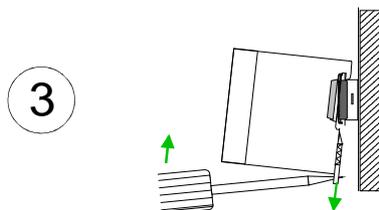
## Demounting and module exchange



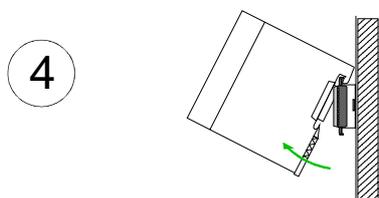
- Remove if exists the wiring to the module, by pressing both locking lever on the connector and pulling the connector.



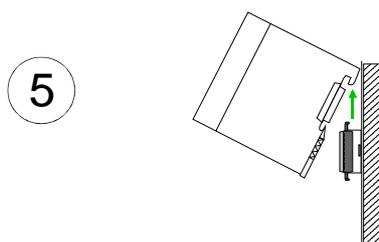
- The casing of the module has a spring loaded clip at the bottom by which the module can be removed.



- The clip is unlocked by pressing the screwdriver in an upward direction.



- Withdraw the module with a slight rotation to the top.



### Attention!

Power must be turned off before modules are installed or removed!

Please regard that the backplane bus is interrupted at the point where the module was removed!

# Wiring

## Overview

Most peripheral modules are equipped with a 10pole or a 18pole connector. This connector provides the electrical interface for the signaling and supply lines of the modules.

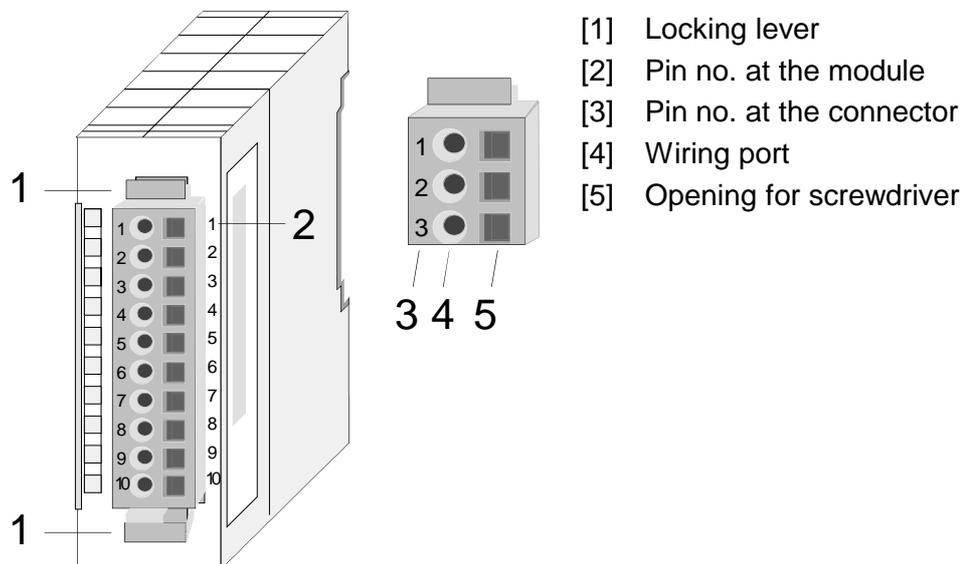
The modules carry spring-clip connectors for interconnections and wiring.

The spring-clip connector technology simplifies the wiring requirements for signaling and power cables.

In contrast to screw terminal connections, spring-clip wiring is vibration proof. The assignment of the terminals is contained in the description of the respective modules.

You may connect conductors with a diameter from 0.08mm<sup>2</sup> up to 2.5mm<sup>2</sup> (max. 1.5mm<sup>2</sup> for 18pole connectors).

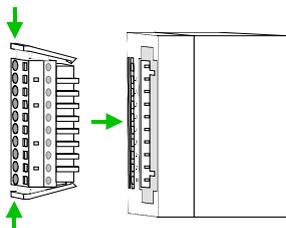
The following figure shows a module with a 10pole connector.



### Note!

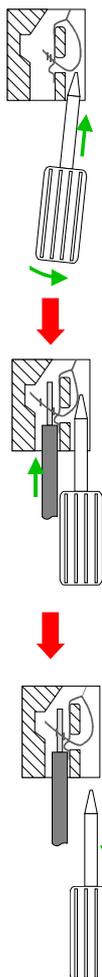
The spring-clip is destroyed if you push the screwdriver into the wire port! Make sure that you only insert the screwdriver into the square hole of the connector!

### Wiring procedure



- Install the connector on the module until it locks with an audible click. For this purpose you press the two clips together as shown. The connector is now in a permanent position and can easily be wired.

The following section shows the wiring procedure from top view.



- Insert a screwdriver at an angle into the square opening as shown.
- Press and hold the screwdriver in the opposite direction to open the contact spring.
- Insert the stripped end of the wire into the round opening. You can use wires with a diameter of 0.08mm<sup>2</sup> to 2.5mm<sup>2</sup> (1.5mm<sup>2</sup> for 18pole connectors).
- By removing the screwdriver the wire is connected safely with the plug connector via a spring.



#### Note!

Wire the power supply connections first followed by the signal cables (inputs and outputs).

## Installation guidelines

**General** The installation guidelines contain information about the interference free deployment of System 200V systems. There is the description of the ways, interference may occur in your control, how you can make sure the electromagnetic digestibility (EMC), and how you manage the isolation.

**What means EMC?** Electromagnetic digestibility (EMC) means the ability of an electrical device, to function error free in an electromagnetic environment without being interferenced res. without interfering the environment.  
All System 200V components are developed for the deployment in hard industrial environments and fulfill high demands on the EMC. Nevertheless you should project an EMC planning before installing the components and take conceivable interference causes into account.

**Possible interference causes** Electromagnetic interferences may interfere your control via different ways:

- Fields
- I/O signal conductors
- Bus system
- Current supply
- Protected earth conductor

Depending on the spreading medium (lead bound or lead free) and the distance to the interference cause, interferences to your control occur by means of different coupling mechanisms.

One differs:

- galvanic coupling
- capacitive coupling
- inductive coupling
- radiant coupling

**Basic rules for EMC**

In the most times it is enough to take care of some elementary rules to guarantee the EMC. Please regard the following basic rules when installing your PLC.

- Take care of a correct area-wide grounding of the inactive metal parts when installing your components.
  - Install a central connection between the ground and the protected earth conductor system.
  - Connect all inactive metal extensive and impedance-low.
  - Please try not to use aluminum parts. Aluminum is easily oxidizing and is therefore less suitable for grounding.
- When cabling, take care of the correct line routing.
  - Organize your cabling in line groups (high voltage, current supply, signal and data lines).
  - Always lay your high voltage lines and signal res. data lines in separate channels or bundles.
  - Route the signal and data lines as near as possible beside ground areas (e.g. suspension bars, metal rails, tin cabinet).
- Proof the correct fixing of the lead isolation.
  - Data lines must be laid isolated.
  - Analog lines must be laid isolated. When transmitting signals with small amplitudes the one sided laying of the isolation may be favorable.
  - Lay the line isolation extensively on an isolation/protected earth conductor rail directly after the cabinet entry and fix the isolation with cable clamps.
  - Make sure that the isolation/protected earth conductor rail is connected impedance-low with the cabinet.
  - Use metallic or metalized plug cases for isolated data lines.
- In special use cases you should appoint special EMC actions.
  - Wire all inductivities with erase links.
  - Please consider luminescent lamps can influence signal lines.
- Create a homogeneous reference potential and ground all electrical operating supplies when possible.
  - Please take care for the targeted employment of the grounding actions. The grounding of the PLC is a protection and functionality activity.
  - Connect installation parts and cabinets with the System 200V in star topology with the isolation/protected earth conductor system. So you avoid ground loops.
  - If potential differences between installation parts and cabinets occur, lay sufficiently dimensioned potential compensation lines.

**Isolation of conductors**

Electrical, magnetically and electromagnetic interference fields are weakened by means of an isolation, one talks of absorption.

Via the isolation rail, that is connected conductive with the rack, interference currents are shunt via cable isolation to the ground. Hereby you have to make sure, that the connection to the protected earth conductor is impedance-low, because otherwise the interference currents may appear as interference cause.

When isolating cables you have to regard the following:

- If possible, use only cables with isolation tangle.
- The hiding power of the isolation should be higher than 80%.
- Normally you should always lay the isolation of cables on both sides. Only by means of the both-sided connection of the isolation you achieve high quality interference suppression in the higher frequency area. Only as exception you may also lay the isolation one-sided. Then you only achieve the absorption of the lower frequencies. A one-sided isolation connection may be convenient, if:
  - the conduction of a potential compensating line is not possible
  - analog signals (some mV res.  $\mu$ A) are transferred
  - foil isolations (static isolations) are used.
- With data lines always use metallic or metalized plugs for serial couplings. Fix the isolation of the data line at the plug rack. Do not lay the isolation on the PIN 1 of the plug bar!
- At stationary operation it is convenient to strip the insulated cable interruption free and lay it on the isolation/protected earth conductor line.
- To fix the isolation tangles use cable clamps out of metal. The clamps must clasp the isolation extensively and have well contact.
- Lay the isolation on an isolation rail directly after the entry of the cable in the cabinet. Lead the isolation further on to the System 200V module and **don't** lay it on there again!

**Please regard at installation!**

At potential differences between the grounding points, there may be a compensation current via the isolation connected at both sides.

Remedy: Potential compensation line.

## General data

### Structure/ dimensions

- Profile rail 35mm
- Peripheral modules with recessed labelling
- Dimensions of the basic enclosure:  
1tier width: (HxWxD) in mm: 76x25.4x74 in inches: 3x1x3  
2tier width: (HxWxD) in mm: 76x50.8x74 in inches: 3x2x3

### Reliability

- Wiring by means of spring pressure connections (CageClamps) at the front-facing connector, core cross-section 0.08 ... 2.5mm<sup>2</sup> or 1.5 mm<sup>2</sup> (18pole plug)
- Complete isolation of the wiring when modules are exchanged
- Every module is isolated from the backplane bus
- ESD/Burst acc. IEC 61000-4-2 / IEC 61000-4-4 (to level 3)
- Shock resistance acc. IEC 60068-2-6 / IEC 60068-2-27 (1G/12G)
- Class of protection IP20

### Environmental conditions

- Operating temperature: 0 ... +60°C
- Storage temperature: -25 ... +70°C
- Relative humidity: 5 ... 95% without condensation
- Ventilation by means of a fan is not required



## Chapter 2 Hardware description

**Overview** Here the hardware components of the IM 26x-1xA00 described.  
The technical data are at the end of the chapter.

<b>Contents</b>	<b>Topic</b>	<b>Page</b>
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	Properties.....	2-2
	IM 260 - Structure.....	2-3
	IM 261 - Structure.....	2-4
	Technical data.....	2-5

## Properties

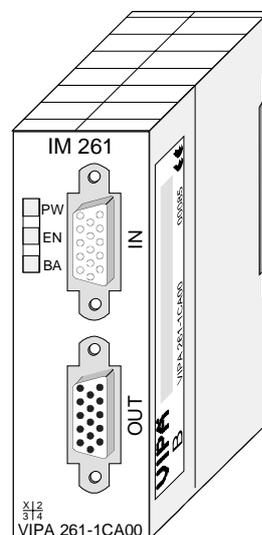
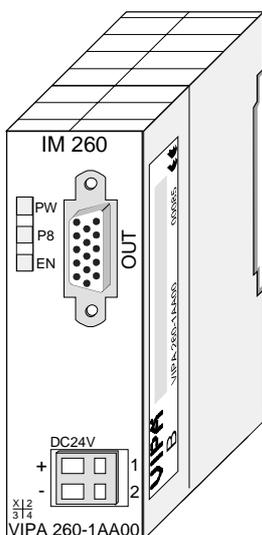
### IM 260

260-1AA00

### IM 261

261-1CA00

- Basic interface with up to 3 System 200V Row interfaces (connected via cable)
- Bus expansion up to 4 rows
- Basic interface with integrated power supply
- max. 32 modules (16 digital modules and 16 analog modules)
- Status indication via LEDs

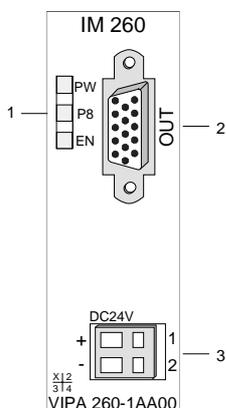


### Ordering data

Type	Order number	Description
IM 260	VIPA 260-1AA00	Basic interface IM 260
IM 261	VIPA 261-1CA00	Row interface IM 261
Cable 0.5m	VIPA 260-1XY05	Interconnecting cable, 0.5m length
Cable 1m	VIPA 260-1XY10	Interconnecting cable, 1m length
Cable 1.5m	VIPA 260-1XY15	Interconnecting cable, 1.5m length
Cable 2m	VIPA 260-1XY20	Interconnecting cable, 2m length
Cable 2.5m	VIPA 260-1XY25	Interconnecting cable, 2.5m length

## IM 260 - Structure

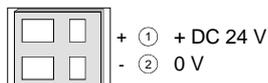
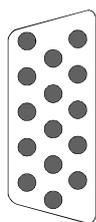
Front view  
Basic interface  
IM 260



- [1] LED status indicator
- [2] Connector bus expansion
- [3] DC 24V power supply connector

### Interfaces

Basic interface  
OUT



### Power supply

The Basic interface has an internal power supply. This is connected to an external supply voltage via two terminals located on the front of the unit. The internal power supply is to be supplied with DC 24V (see Technical Data).

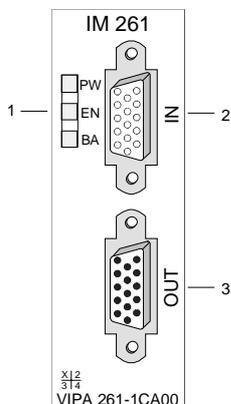
### LEDs

The Basic interface has 3 LEDs on its front side. In the following the usage and the according colors of the LEDs are described.

LED	Color	Description
PW	green	Supply voltage available
P8	yellow	Supply voltage for subsequent rows is active
EN	yellow	Backplane bus communications active

## IM 261 - Structure

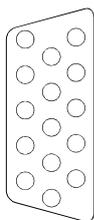
Front view  
Row interface  
IM 261



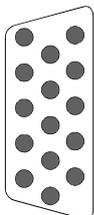
- [1] LED status indicator
- [2] Connector bus expansion IN
- [3] Connector bus expansion OUT

### Interfaces

Row interface  
IN



OUT



### LEDs

The Row interface has 3 LEDs on its front side. In the following the usage and the according colors of the LEDs is described.

LED	Color	Description
PW	green	Supply voltage available via IM 260
EN	yellow	Backplane bus communication active
BA	red	Outputs inhibited (BASP) is active

## Technical data

### 260-1AA00

<b>Order number</b>	<b>260-1AA00</b>
Type	IM 260, Basic interface
<b>Technical data power supply</b>	
Power supply (rated value)	DC 24 V
Power supply (permitted range)	DC 20.4...28.8 V
Reverse polarity protection	✓
Current consumption (no-load operation)	50 mA
Current consumption (rated value)	1.9 A
Inrush current	-
Max. current drain at backplane bus	4 A
Max. current drain load supply	-
Power loss	2 W
<b>Status information, alarms, diagnostics</b>	
Status display	yes
Interrupts	no
Process alarm	no
Diagnostic interrupt	no
Diagnostic functions	no
Diagnostics information read-out	none
Supply voltage display	yes
Group error display	none
Channel error display	none
<b>Hardware configuration</b>	
Racks, max.	4
Modules per rack, max.	16
Number of digital modules, max.	16
Number of analog modules, max.	16
<b>Housing</b>	
Material	PPE / PA 6.6
Mounting	Profile rail 35 mm
<b>Mechanical data</b>	
Dimensions (WxHxD)	25.4 x 76 x 78 mm
Weight	100 g
<b>Environmental conditions</b>	
Operating temperature	0 °C to 60 °C
Storage temperature	-25 °C to 70 °C
<b>Certifications</b>	
UL508 certification	yes

### Additional Technical Data

<b>Order number</b>	<b>260-1AA00</b>
<b>Construction</b>	
max. cable distance between 1. and last row	2.5m

## 261-1CA00

<b>Order number</b>	<b>261-1CA00</b>
Type	IM 261, Row interface
<b>Technical data power supply</b>	
Power supply (rated value)	-
Power supply (permitted range)	-
Reverse polarity protection	-
Current consumption (no-load operation)	-
Current consumption (rated value)	-
Inrush current	-
Max. current drain at backplane bus	1.5 A
Max. current drain load supply	-
Power loss	1 W
<b>Status information, alarms, diagnostics</b>	
Status display	yes
Interrupts	no
Process alarm	no
Diagnostic interrupt	no
Diagnostic functions	no
Diagnostics information read-out	none
Supply voltage display	yes
Group error display	none
Channel error display	none
<b>Hardware configuration</b>	
Racks, max.	1
Modules per rack, max.	16
Number of digital modules, max.	16
Number of analog modules, max.	16
<b>Housing</b>	
Material	PPE
Mounting	Profile rail 35 mm
<b>Mechanical data</b>	
Dimensions (WxHxD)	25.4 x 76 x 78 mm
Weight	90 g
<b>Environmental conditions</b>	
Operating temperature	0 °C to 60 °C
Storage temperature	-25 °C to 70 °C
<b>Certifications</b>	
UL508 certification	yes

# Chapter 3 Deployment

## Overview

In this chapter follows the description of the bus expansion module IM 260 and IM 261. About the basic interface up to 3 System 200V row interfaces can be connected via cable. Here the maximum number of 32 modules (16 digital modules and 16 analog modules) may not be exceeded.

## Contents

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## Field of application

### Overview

The system consisting of IM 260, IM 261 and interconnecting cables is an expansion option that you use to split the System 200V over up to 4 rows.

This system may only be installed in a centralized System 200V where a PC 288 or a CPU is employed as the master station!

For bus expansion purposes you always have to include the basic interface IM 260. The basic interface may then be connected to up to 3 additional System 200V rows by means of the appropriate interconnecting cables and the IM 261 interfacing module for rows.



### Please note!

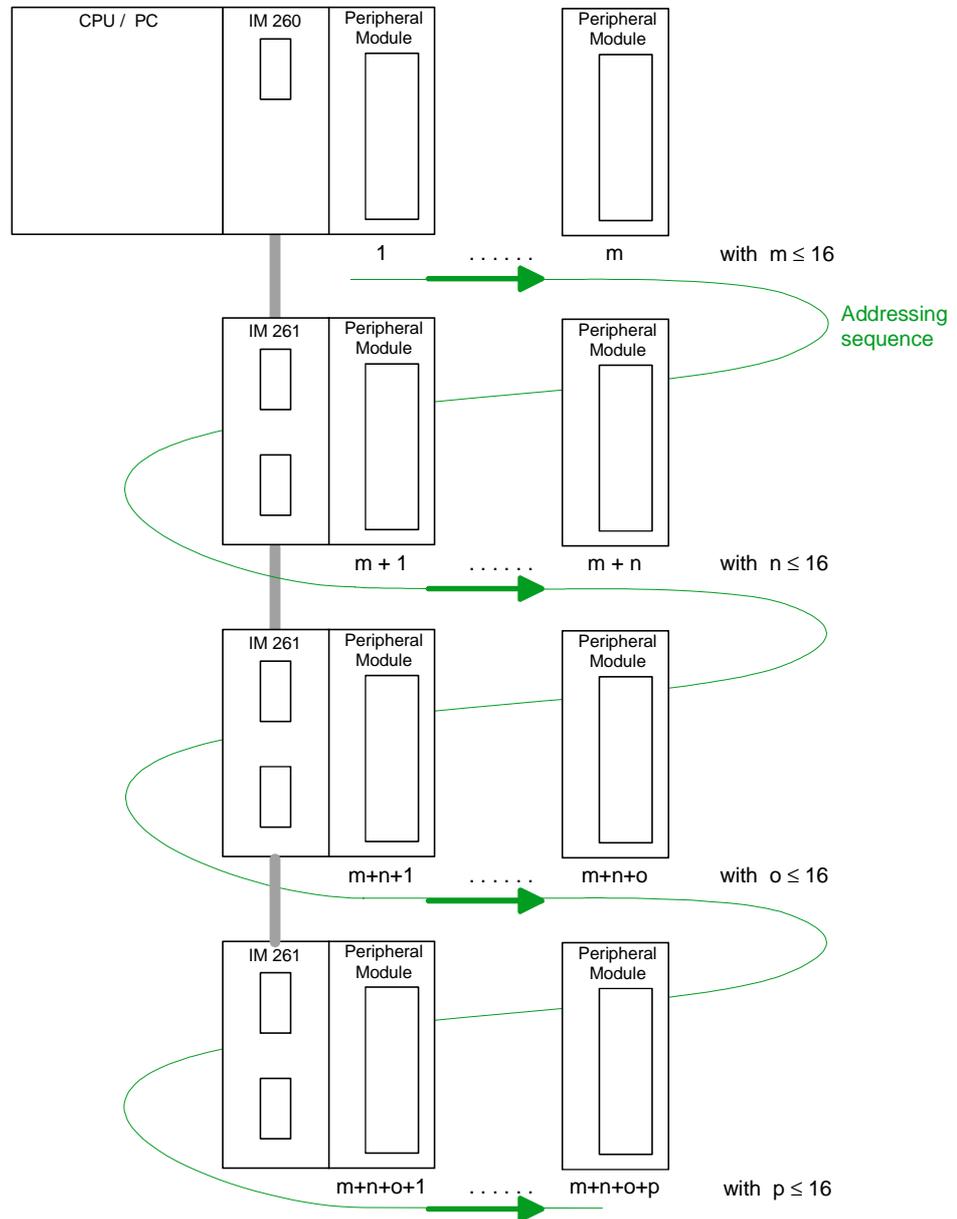
Certain rules and regulations have to be observed when the bus expansion modules are being employed:

- The bus expansion may only be used in conjunction with the PC 288 (VIPA 288-2BL10) or a CPU (combined CPUs are also permitted). The system must never be employed in decentralized systems, e.g. behind a PROFIBUS DP slave!
- The system caters for a maximum of 4 rows.
- Every row can carry a maximum of 16 peripheral modules.
- The max. total quantity of 32 peripheral modules may not be exceeded.
- In critical environments the total length of interconnecting cables should not exceed a max. of 2m.
- Every row may derive a max. current of 1.5A from the backplane bus, while the total current is limited to 4A.
- At least one peripheral module must be installed next to the IM 260 basic interface!

# Wiring

## Configuration

The following figure shows the structure of a bus expansion under observance of the installation requirements and rules:



Where:  $m + n + o + p \leq 32$



### Note!

The bus expansion may only be used in conjunction with the PC 288 (VIPA 288-2BL10) or a CPU (combined CPUs are also permitted)!

The bus expansion module is supported as of the following minimum firm-ware revision levels:

CPU compatible with Siemens STEP<sup>®</sup>5: from Version 2.07

CPU compatible with Siemens STEP<sup>®</sup>7: from Version 1.0

